

## AMENDMENTS TO THE CLAIMS

### Listing of Claims:

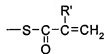
The following listing of claims replaces all previous listings or versions thereof:

1-63. (Canceled)

64. (Previously presented) A photocurable adhesive composition comprising ~~consisting of~~, based on the total weight of the photopolymerizable monomers and/or oligomers of the composition:

5 to 60 wt% of at least one non-aromatic mono or polyacrylate diacrylate monomer or oligomer thereof or a mixture of non-aromatic mono or diacrylate monomers thereof and aromatic acrylate monomers (A);

5 to 50 wt% of at least one thio(meth)acrylate monomer or oligomer thereof (B), bearing



at least one ~~function~~functional group, in which R' is H or —CH<sub>3</sub>;  
and

20 to 50 wt% of at least one aromatic dimethacrylate monomer or oligomer thereof (C);  
0% or 10 to 30 wt% of a monomethacrylate monomer (D); and  
at least one photoinitiator;

with the proviso that the composition does not contain a brominated monofunctional acrylate.

65. (Currently amended) The composition of claim 64, comprising wherein:

(A) is at least 15 wt% of (A);

(B) is at least 9 wt% of (B); and

(C) is at least 25 wt% of (C).

66. (Currently amended) The composition of claim 64, comprising wherein:

(A) is 20 to 60 wt% of at least one mono or polyacrylate monomer or oligomer thereof (A);

(B) is 20 to 50 wt% of at least one thio(meth)acrylate monomer or oligomer thereof (B);  
and

(C) is 20 to 40 wt% based on the total weight of the photopolymerizable composition of at least one aromatic dimethacrylate monomer or oligomer thereof (C).

67. (Currently amended) The composition of claim 64, ~~comprising~~wherein (A) is 20 to 60 wt% of (A), (B) is 30 to 50 wt% of (B) and (C) is 20 to 40 wt% of (C).

68. (Currently amended) The composition of claim 64, ~~comprising~~wherein:

(A) is 20 to 50 wt% of at least one mono or polyacrylate monomer or oligomer thereof

(A);

(B) is 30 to 50 wt% of at least one thio(meth)acrylate monomer or oligomer thereof (B);

and

(C) is 20 to 40 wt% of at least one aromatic dimethacrylate monomer or oligomer thereof

(C).

69. (Currently amended) The composition of claim 64, ~~comprising~~consisting of:

20 to 40 wt% of at least one mono or polyacrylate monomer or oligomer thereof (A);

35 to 45 wt% of at least one thio(meth)acrylate monomer or oligomer thereof (B); and

25 to 35 wt% of at least one aromatic dimethacrylate monomer or oligomer thereof (C).

70. (Previously presented) The composition of claim 64, wherein said at least one mono or polyacrylate monomer (A) has a calculated solubility parameter ranging from 8 to 12  $(\text{cal}/\text{cm}^3)^{1/2}$ .

71. (Previously presented) The composition of claim 70, wherein said at least one mono or polyacrylate monomer (A) has a calculated solubility parameter ranging from 8.5 to 11.5  $(\text{cal}/\text{cm}^3)^{1/2}$ .

72. (Previously presented) The composition of claim 64, wherein said at least one mono or polyacrylate monomer (A) has a molecular weight  $< 500$ .

73. (Previously presented) The composition of claim 72, wherein said at least one mono or polyacrylate monomer (A) has a molecular weight  $\leq 350$ .

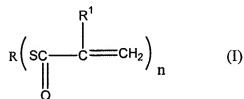
74. (Previously presented) The composition of claim 64, wherein said at least one monomer (A) is a low refractive index monomer.

75. (Canceled)

76. (Currently amended) The composition of claim [[75]]64, wherein monomer (A) is diethyleneglycol diacrylate, triethyleneglycol diacrylate, tetraethyleneglycol diacrylate, neopentylglycoldiacrylate, 1,6-hexanediol diacrylate or tetrahydrofurfuryl acrylate.

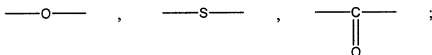
77. (Previously presented) The composition of claim 64, wherein the at least one thio(meth)acrylate monomer (B) is a high refractive index monomer.

78. (Previously presented) The composition of claim 64, wherein the at least one thio(meth)acrylate monomer (B) is a monomer of formula:



wherein:

R is a linear or branched, monovalent or polyvalent, aliphatic hydrocarbon radical, or a monovalent or polyvalent aromatic group directly linked to the sulfur atom of the thio(meth)acrylate group(s) through an aromatic ring or by means of a linear alkyl chain, the radical R may include in its chain one or more of:



R<sup>1</sup> is H or -CH<sub>3</sub>; and

n is an integer from 1 to 6.

79. (Previously presented) The composition of claim 64, wherein the at least one aromatic dimethacrylate monomer (C) is an ethoxylated bisphenol-A monomer.

80. (Canceled)

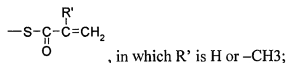
81. (Currently amended) The composition of claim [[80]]64, wherein the photoinitiator represents 0.1 to 5 parts by weight for 100 parts by weight of the polymerizable monomers and/or oligomers.

82. (Previously presented) The composition of claim 64, wherein, after curing, the adhesive composition has a refractive index of 1.53 to 1.65.

83. (Currently amended/withdrawn) A process comprising:  
providing a thermoplastic material substrate having at least one main surface;  
providing a support having an internal surface bearing a coating and an external surface;  
depositing on the main surface of the substrate or on the coating a pre-measured amount of a photocurable adhesive composition comprising~~comprising~~consisting of, based on total weight of photopolymerizable monomer and/or oligomers of the composition:

5 to 60 wt% of at least one non-aromatic mono or polyacrylatediacrylate monomer or oligomer thereof or a mixture of non-aromatic mono or diacrylate monomers thereof and aromatic acrylate monomers, (A);

5 to 50 wt% of at least one thio(meth)acrylate monomer or oligomer thereof [I,] (B)[I;], and at last one functional group



20 to 50 wt% of at least on aromatic dimethacrylate monomer or oligomer thereof, (C);

0% or 10 to 30 wt% of a monomethacrylate monomer (D); and  
at least one photoinitiator;

with the proviso that the composition does not contain a brominated monofunctional acrylate;  
moving relatively to each other the substrate and the support to either bring the coating into contact with the curable adhesive composition or bring the curable adhesive composition into contact with the main surface of the substrate;  
applying a sufficient pressure onto the external surface of the support so that the thickness of a final adhesive layer, once the curable adhesive composition has cured is less than 100 µm;  
curing the layer of adhesive composition; and  
withdrawing the support to recover a substrate with the coating adhered onto its main surface.

84. (Currently amended/withdrawn) The process of claim 83, wherein ~~the photocurable adhesive composition comprises:~~

- (A) is at least 15 wt% of ~~(A)~~;
- (B) is at least 9 wt% of ~~(B)~~; and
- (C) is at least 25 wt% of ~~(C)~~.

85. (Currently amended/withdrawn) The process of claim 83, wherein ~~the photocurable adhesive composition comprises:~~

- (A) is 20 to 60 wt% at least one mono or polyacrylate monomer or oligomer thereof ~~(A)~~;
- (B) is 20 to 50 wt% of at least one thio(meth)acrylate monomer or oligomer thereof ~~(B)~~;
- and
- (C) is 20 to 40 wt% based on the total weight of the photopolymerizable composition of at least one aromatic dimethacrylate monomer or oligomer thereof ~~(C)~~.

86. (Currently amended/withdrawn) The process of claim 83, wherein ~~the photocurable adhesive composition comprises~~ (A) is 20 to 60 wt% of ~~(A)~~, (B) is 30 to 50 wt% of ~~(B)~~ and (C) is 20 to 40 wt% of ~~(C)~~.

87. (Currently amended/withdrawn) The process of claim 83, wherein ~~the photocurable adhesive composition comprises:~~

- (A) is 20 to 50 wt% of at least one mono or polyacrylate monomer or oligomer thereof ~~(A)~~;
- (B) is 30 to 50 wt% of at least one thio(meth)acrylate monomer or oligomer thereof ~~(B)~~;
- and
- (C) is 20 to 40 wt% of at least one aromatic dimethacrylate monomer or oligomer thereof ~~(C)~~.

88. (Currently amended/withdrawn) The process of claim 83, wherein ~~the photocurable adhesive composition comprises:~~

- (A) is 20 to 40 wt% of at least one mono or polyacrylate monomer or oligomer thereof ~~(A)~~;
- (B) is 35 to 45 wt% of at least one thio(meth)acrylate monomer or oligomer thereof ~~(B)~~;
- and

(C) is 25 to 35 wt% of at least one aromatic dimethacrylate monomer or oligomer thereof  
(C).

89. (Withdrawn) The process of claim 83, wherein the thermoplastic material of the substrate is a high refractive index material.

90. (Withdrawn) The process of claim 83, wherein the thermoplastic material of the substrate is polycarbonate.

91. (Withdrawn) The process of claim 83, wherein said at least one mono or polyacrylate monomer (A) has a calculated solubility parameters ranging from 8 to 12 (cal/cm<sup>3</sup>)<sup>1/2</sup>.

92. (Withdrawn) The process of claim 91, wherein said at least one mono or polyacrylate monomer (A) has a calculated solubility parameter ranging from 8.5 to 11.5 (cal/cm<sup>3</sup>)<sup>1/2</sup>.

93. (Withdrawn) The process of claim 83, wherein said at least one mono or polyacrylate monomer (A) has a molecular weight < 500.

94. (Withdrawn) The process of claim 93, wherein said at least one monomer (A) has a molecular weight ≤ 350.

95. (Withdrawn) The process of claim 83, wherein said at least one monomer (A) is a low refractive index monomer.

96. (Canceled)

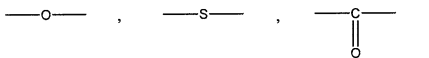
97. (Currently amended/withdrawn) The process of claim ~~[[96]]~~83, wherein monomer (A) is diethyleneglycol diacrylate, triethyleneglycol diacrylate, tetraethyleneglycol diacrylate, neopentylglycoldiacrylate, 1,6-hexanediol diacrylate and tetrahydrofurfuryl acrylate.

98. (Withdrawn) The process of claim 83, wherein the said at least one thio(meth)acrylate monomer (B) is a high refractive index monomer.

99. (Withdrawn) The process of claim 83, wherein the at least one thio(meth)acrylate monomer (B) is a monomer of formula:



R is a linear or branched, monovalent or polyvalent, aliphatic hydrocarbon radical, or a monovalent or polyvalent aromatic group directly linked to the sulfur atom of the thio(meth)acrylate group(s) through an aromatic ring or by means of a linear alkyl chain, the radical R may include in its chain one or more of:



$n$  is an integer from 1 to 6.

- 60269206.1

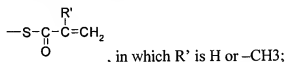
107. (Withdrawn) The process of claim 106, wherein the flexible support is urged against the lens blank by means of an inflatable membrane.
108. (Withdrawn) The process of claim 83, wherein the support is made of polycarbonate.
109. (Withdrawn) The process of claim 83, wherein the support has a thickness of 0.3 to 1 mm.
110. (Withdrawn) The process of claim 83, wherein the thickness of the final cured adhesive layer is less than 80  $\mu\text{m}$ .
111. (Withdrawn) The process of claim 83, wherein the thickness of the final cured adhesive layer is less than 50  $\mu\text{m}$ .
112. (Withdrawn) The process of claim 83, wherein the final cured adhesive layer has a refractive index of 1.53 to 1.65.
113. (Withdrawn) The process of claim 83, wherein the exerted pressure ranges from 5 to 50 Psi (0.35 to 3.5  $\text{kgf/cm}^2$ ).
114. (Withdrawn) The process of claim 83, wherein the coating comprises a hydrophobic top coat, an anti-reflective coating layer, an anti-abrasion coating layer, an impact resistant coating layer, a photochromic coating layer, a dyeing coating layer a polarized coating layer, a printed layer or a stack of two or more of these coating layers.
115. (Withdrawn) The process of claim 114, wherein the coating has a thickness of 50  $\mu\text{m}$  or less.
116. (Withdrawn) The process of claim 83, wherein the substrate is a semi-finished lens having one face already provided with a coating.
117. (Withdrawn) The process of claim 116, wherein the face already provided with a coating is the front face of the lens and the geometrically defined surface onto which the coating is transferred is the back surface of the lens.
118. (Currently amended/withdrawn) A process which comprises:  
providing a thermoplastic material substrate having at least one main surface;



providing a mold part having an internal surface and an external surface;  
 depositing on the main surface of the substrate or on the internal surface of the mold part  
 a pre-measured amount of a photocurable adhesive composition  
comprisingconsisting of, based on the total weight of photopolymerizable  
 monomers and/or oligomers of the composition:

5 to 60 wt% of at least one non-aromatic mono or polyacrylatediacrylate  
monomer or oligomer thereof or a mixture of non-aromatic mono  
or diacrylate monomers thereof and aromatic acrylate monomers,  
 (A);

5 to 50 wt% of at least one thio(meth)acrylate monomer or oligomer  
 thereof[[,]] (B)[[;]], and at last one functional group



20 to 50 wt% of at least on aromatic dimethacrylate monomer or oligomer  
 thereof, (C);

0% or 10 to 30 wt% of a monomethacrylate monomer (D); and  
at least one photoinitiator;

with the proviso that the composition does not contain a brominated  
 monofunctional acrylate;

moving relatively to each other the substrate and the mold part to either bring the internal  
 surface of the mold part or the main surface of the substrate in contact with the  
 curable adhesive composition;

applying a sufficient pressure onto the external surface of the mold part to uniformly  
 spread the curable adhesive composition and form a uniform layer, which, when  
 cured, has a thickness of at least 200 µm.

curing the layer of adhesive composition; and

withdrawing the mold parts to recover the substrate overmolded with a cured layer of the  
 curable adhesive composition.

119. (Currently amended/withdrawn) The process of claim 118, wherein ~~the photocurable adhesive composition comprises:~~

- ~~(A) is at least 15 wt% of (A);~~
- ~~(B) is at least 9 wt% of (B); and~~
- ~~(C) is at least 25 wt% of (C).~~

120. (Currently amended/withdrawn) The process of claim 118, wherein ~~the photocurable adhesive composition comprises:~~

- ~~(A) is 20 to 60 wt% at least one mono or polyacrylate monomer or oligomer thereof (A);~~
- ~~(B) is 20 to 50 wt% of at least one thio(meth)acrylate monomer or oligomer thereof (B);~~
- ~~and~~
- ~~(C) is 20 to 40 wt% based on the total weight of the photopolymerizable composition of at least one aromatic dimethacrylate monomer or oligomer thereof (C).~~

121. (Currently amended/withdrawn) The process of claim 120, wherein ~~the photocurable adhesive composition comprises~~ (A) is 20 to 60 wt% of (A), (B) is 30 to 50 wt% of (B) and 20 to 40 wt% of (C).

122. (Currently amended/withdrawn) The process of claim 118, wherein ~~the photocurable adhesive composition comprises:~~

- ~~(A) is 20 to 50 wt% of at least one mono or polyacrylate monomer or oligomer thereof (A);~~
- ~~(B) is 30 to 50 wt% of at least one thio(meth)acrylate monomer or oligomer thereof (B);~~
- ~~and~~
- ~~(C) is 20 to 40 wt% of at least one aromatic dimethacrylate monomer or oligomer thereof (C).~~

123. (Currently amended/withdrawn) The process of claim 118, wherein ~~the photocurable adhesive composition comprises:~~

- ~~(A) is 20 to 40 wt% of at least one mono or polyacrylate monomer or oligomer thereof (A);~~
- ~~(B) is 35 to 45 wt% of at least one thio(meth)acrylate monomer or oligomer thereof (B);~~
- ~~and~~

(C) is 25 to 35 wt% of at least one aromatic dimethacrylate monomer or oligomer thereof (C).

124. (Withdrawn) The process of claim 118, wherein a coating to be transferred is applied to the internal surface of the mold part before depositing the curable adhesive composition.

125. (Withdrawn) The process of claim 118, wherein the overmolded cured layer of curable adhesive composition has a thickness of at least 500  $\mu\text{m}$ .

126. (Currently amended/withdrawn) A process comprising:

depositing a pre-measured amount of a photocurable adhesive composition on a main surface of a first part made of thermoplastic material;

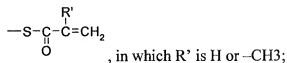
bringing into contact the deposited photocurable adhesive composition with a main surface of a second part made of thermoplastic material;

pressing the first and second parts against each other to uniformly spread the photocurable adhesive composition to form a uniform thin layer; and photocuring the thin layer to obtain a laminated article, wherein the photocurable adhesive composition ~~comprises~~consists of, based on total weight of photopolymerizable monomers and/or oligomers of the composition:

5 to 60 wt% of at least one non-aromatic mono or polyacrylatediacrylate monomer or oligomer thereof or a mixture of non-aromatic mono or diacrylate monomers thereof and aromatic acrylate monomers,

(A);

5 to 50 wt% of at least one thio(meth)acrylate monomer or oligomer thereof[.], (B)[[.], and at last one functional group



20 to 50 wt% of at least on aromatic dimethacrylate monomer or oligomer thereof, (C);

0% or 10 to 30 wt% of a monomethacrylate monomer (D); and at least one photoinitiator;

with the proviso that the composition does not contain a brominated monofunctional acrylate.

127. (Withdrawn) The process of claim 126, wherein the article is an ophthalmic lens.

128. (New) The photocurable adhesive composition of claim 64, wherein (D) is 10 to 30 wt% of a monomethacrylate monomer.

129. (New) The photocurable adhesive composition of claim 64, wherein (D) is 10 to 30 wt% of a monomethacrylate monomer, and is further defined as an aromatic monomethacrylate monomer.

130. (New) The photocurable adhesive composition of claim 64, wherein (A) is 5 to 60 wt% of at least one non-aromatic mono or diacrylate monomer or oligomer thereof or a mixture of non-aromatic mono or diacrylate monomers or oligomers thereof and aromatic monoacrylate monomers.

131. (New) The photocurable adhesive composition of claim 64, wherein (A) is 5 to 60 wt% of at least one non-aromatic mono or diacrylate monomer or oligomer thereof or a mixture of non-aromatic mono or diacrylate monomers or oligomers thereof and aromatic monoacrylate monomers (A), and wherein (D) is an aromatic monomethacrylate monomer.